

Data sheet Product ICKLEDR54x20_

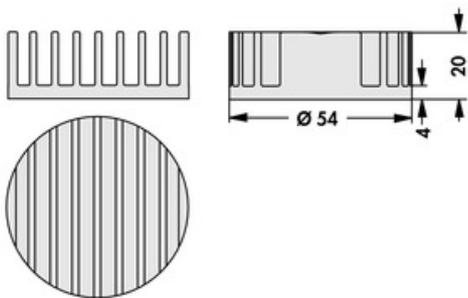


Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 54 x 20 mm, for IC design LED

Features

diameter:	54 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	20 mm
plate thickness:	4 mm
thermal resistance:	9.48 K/W
dissipation loss:	12.1 W
surface:	black anodised

Technical Drawing



$$R_{th} = 9,48 \text{ K/W}$$